## 2 MHz Boost DC/DC Converter with 2.5A Switch and Soft-Start

## feATURES

- 2.5A, 0.12 $\Omega, 40 \mathrm{~V}$ Internal Switch
- 2MHz Switching Frequency
- Integrated Soft-Start Function
- $V_{\text {IN }}$ Range: 2.6 V to 16 V
- Adjustable Output from $\mathrm{V}_{\text {IN }}$ to 40 V
- Low $\mathrm{V}_{\text {CESAT }}$ Switch: 110 mV at 1 A (Typical)
- 8 V at 610 mA from a 3.3 V Input
- Internal or External Loop Compensation
- Small 8-Lead MS8E


## APPLICATIONS

- TFT-LCD Bias Supplies
- GPS Receivers
- DSL Modems
- Local Power Supply


## DESCRIPTIOn

The LT ${ }^{\circledR} 3489$ is a fixed frequency step-up DC/DC converter containing an internal 2.5A, 40V switch. The LT3489 is ideal for large TFT-LCD panel power supplies. The LT3489 switches at 2 MHz , allowing the use of tiny, low profile inductors and low value ceramic capacitors. Loop compensation can be either internal or external, giving the user flexibility in setting loop compensation and allowing optimized transient response with low ESR ceramic output capacitors. Soft-start is controlled with an external capacitor, which determines the input current ramp rate during start-up.
The 8-lead MS8E package and high switching frequencyensure a low profile overall solution less than 1.1 mm high.
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## TYPICAL APPLICATION

Low Profile, Triple Output TFT Supply (8V, $-8 \mathrm{~V}, 23 \mathrm{~V}$ )


Efficiency

ABSOLUTE MAXIMUM RATINGS
(Note 1)
VIN Voltage ..... 16 V
SW Voltage ..... -0.4 V to 40 V
FB, VC, COMP, SS Voltages ..... 6 V
SHDN Voltage ..... 16V
Current Into FB Pin ..... $\pm 1 \mathrm{~mA}$
Maximum Junction Temperature ..... $125^{\circ} \mathrm{C}$
Operating Temperature Range (Note 2) $\ldots-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage Temperature Range

$\qquad$
$-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$................. $300^{\circ} \mathrm{C}$PACKAGE/ORDER INFORMATION

|  |  |
| :---: | :---: |
|  |  |
|  | KAGE IC MSOP <br> ${ }^{\circ} \mathrm{CN}, \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}$ <br> UST BE SOLDERED TO PCB) |
| ORDER PART NUMBER | MS8E PART MARKING |
| LT3489EMS8E | LTBYF |

Order Options Tape and Reel: Add \#TR
Lead Free: Add \#PBF Lead Free Tape and Reel: Add \#TRPBF Lead Free Part Marking: http://www.linear.com/leadfree/

Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} . \mathrm{V}_{I N}=3 \mathrm{~V}, \mathrm{~V}_{\overline{S H D N}}=\mathrm{V}_{I N}$ unless otherwise noted. (Note 2)

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Minimum Operating Voltage |  |  |  | 2.4 | 2.6 | V |
| Maximum Operating Voltage |  |  |  |  | 16 | V |
| Feedback Voltage |  | $\bullet$ | $\begin{aligned} & 1.22 \\ & 1.21 \end{aligned}$ | 1.235 | $\begin{aligned} & 1.26 \\ & 1.26 \end{aligned}$ | V |
| FB Pin Bias Current | $\mathrm{V}_{\text {FB }}=1.25 \mathrm{~V}$ (Note 3) | $\bullet$ |  | 100 | 250 | nA |
| Error Amp Transconductance | $\Delta I=10 \mu \mathrm{~A}$ |  |  | 100 |  | $\mu \mathrm{mhos}$ |
| Error Amp Voltage Gain |  |  |  | 80 |  | V/V |
| Quiescent Current | $\mathrm{V}^{\overline{\text { SHDN }}}=2.5 \mathrm{~V}$, Not Switching |  |  | 2 | 4 | mA |
| Quiescent Current in Shutdown | $\mathrm{V}_{\widehat{S H D N}}=0 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=3 \mathrm{~V}$ |  |  | 0 | 1 | $\mu \mathrm{A}$ |
| Reference Line Regulation | $2.6 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 16 \mathrm{~V}$ |  |  | 0.01 | 0.05 | \% |
| Switching Frequency |  | $\bullet$ | 1.8 | 2 | 2.2 | MHz |
| Maximum Switch Duty Cycle |  | $\bullet$ | 85 | 90 |  | \% |
| Switch Current Limit | (Note 4) | $\bullet$ | 2.5 | 3.5 | 5 | A |
| Switch V CESAT | $\mathrm{I}_{\text {SW }}=2 \mathrm{~A}$ |  |  | 0.23 |  | V |
| Switch Leakage Current | $V_{S W}=5 \mathrm{~V}$ |  |  | 0.01 | 1 | $\mu \mathrm{A}$ |
| $\overline{\overline{\text { SHDN }} \text { Pin Current }}$ | $\begin{aligned} & V \overline{S H D N}=5 \mathrm{~V} \\ & V_{\text {SHDN }}=1.4 \mathrm{~V} \\ & V \overline{\text { SHDN }}=0 \mathrm{~V} \\ & \hline \end{aligned}$ |  |  | $\begin{gathered} 100 \\ 20 \\ 2 \\ \hline \end{gathered}$ |  | $\mu A$ $\mu A$ $\mu A$ |
| $\overline{\text { SHDN Pin Threshold }}$ |  |  | 0.3 | 1.5 | 2 | V |
| Soft-Start Charging Current | $\mathrm{V}_{\text {SS }}=0.5 \mathrm{~V}$ |  | 5 | 10 | 20 | $\mu \mathrm{A}$ |

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.
Note 2: The LT3489E is guaranteed to meet performance specifications from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$. Specifications over the $40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ operating
temperature range are assured by design, characterization and correlation with statistical process controls.
Note 3: Current flows out of the FB pin.
Note 4: Current limit guaranteed by design and/or correlation to static test. Current limit is independent of duty cycle and is guaranteed by design.

## TYPICAL PERFORMARCG CHARACTERISTICS $T_{A}=25^{5}$ c unless ontemise noted.



3489 G01


Oscillator Frequency


3489 G02

Quiescent Current


Current Limit


Switching Waveform for the Cover Page Circuit


## PIn functions

$\mathbf{V}_{\mathbf{C}}$ (Pin1): ErrorAmplifier Output Pin. Tie external compensation network to this pin, or use the internal compensation network by shorting the $\mathrm{V}_{\mathrm{C}}$ pin to the COMP pin.

FB (Pin 2): Feedback Pin. Reference voltage is 1.235 V . Connect resistive dividertap here. Minimize the trace area at FB. Set $\mathrm{V}_{\text {OUT }}$ according to $\mathrm{V}_{\text {OUT }}=1.235 \bullet(1+\mathrm{R} 1 / \mathrm{R} 2)$.
SHDN (Pin 3): Shutdown Pin. Tie to 2 V or more to enable device. Ground to shut down. Do not float this pin.

GND (Pin 4): Ground. Tie directly to local ground plane. SW (Pin 5): Switch Pin. This is the collector of the internal NPN power switch. Minimize the metal trace area connected to this pin to minimize EMI.
$V_{\text {IN }}$ (Pin 6): Input Supply Pin. Must be locally bypassed.
COMP (Pin 7): Internal Compensation Pin. Provides an internal compensation network. Tie directly to the $\mathrm{V}_{\mathrm{C}}$ pin for internal compensation. Tie to GND if not in use.

SS (Pin 8): Soft-Start Pin. Place a soft-start capacitor here. Upon start-up, $10 \mu \mathrm{~A}$ of current charges the capacitor to 1.8 V . Use a larger capacitor for slower start-up. Leave floating if not in use.

Exposed Pad (Pin 9): Ground. Must be soldered to PCB.

## BLOCK DIAGRAM



Figure 1. Block Diagram

## OPERATION

The LT3489 uses a constant frequency, current mode control scheme to provide excellent line and load regulation. Please refer to Figure 1 for the following description of the part's operation. At the start of the oscillator cycle, the SR latch is set, turning on the power switch, Q1. The switch current flows through the internal current sense resistor generating a voltage. This voltage is added to a stabilizing ramp and the resulting sum is fed into the positive terminal of the PWM comparator, A2. When this voltage exceeds the level at the negative input of A2, the SR latch is reset, turning off the power switch. The level at the negative input of $A 2\left(V_{C}\right.$ pin) is set by the error amplifier $\left(g_{m}\right)$ and is simply an amplified version of the difference between the feedback voltage and the reference voltage of 1.235 V . In this manner, the error amplifier sets the correct peak current level to keep the output in regulation.

A soft-start function is provided to enable a clean start-up for the LT3489. When the part is brought out of shutdown, $10 \mu \mathrm{~A}$ of current is sourced out of the SS pin. By connecting an external capacitor to the SS pin, the rate of voltage rise on the pin can be set. Typical values for the soft-start capacitor range from 10 nF to 200 nF . The SS pin indirectly limits the rate of rise on the $V_{C}$ pin, which in turn limits the peak switch current. Current limit is not shown in Figure 1. The switch current is constantly monitored and not allowed to exceed the nominal value of 2.5 A . If the switch current reaches 2.5 A , the SR latch is reset regardless of the output of comparator A2. This current limit helps protect the power switch as well as the external components connected to the LT3489.

## APPLICATIONS INFORMATION

Inductor Selection

Several inductors that work well with the LT3489 are listed in Table 1. This table is not exclusive; there are many other manufacturers and inductors that can be used. Consult each manufacturer for more detailed information and for their entire selection of related parts, as many different sizes and shapes are available. Ferrite core inductors should be used to obtain the best efficiency, as core losses at 2 MHz are much lower for ferrite cores than for the cheaper powdered-iron ones. Choose an inductor that can handle at least 2.5 A without saturating, and ensure that the inductor has a low DCR (copper wire resistance) to minimize ${ }^{2}$ R power losses. A $2.2 \mu \mathrm{H}$ to $5 \mu \mathrm{H}$ inductor will be the best choice for most LT3489 designs. Note that in some applications, the current handling requirements of the inductor can be lower, such as in the SEPIC topology where each inductor only carries one-half of the total switch current. The inductors shown in Table 1 were chosen for small size. For better efficiency, use similar valued inductors with a larger volume.

## Capacitor Selection

Low ESR (equivalent series resistance) capacitors should be used at the output to minimize the output ripple voltage. Multilayer ceramic capacitors are an excellent choice, as they have an extremely low ESR and are available in very small packages. X5R or X7R dielectrics are preferred, as these materials retain the capacitance over wide voltage and temperature ranges. A $4.7 \mu \mathrm{~F}$ to $20 \mu \mathrm{~F}$ output capacitor is sufficient for most applications, but systems with very low output currents may need only a $1 \mu \mathrm{~F}$ or $2.2 \mu \mathrm{~F}$ output capacitor. Solid tantalum or OS-CON capacitors can be used, but they will occupy more board area than a ceramic and will have a higher ESR. Always use a capacitor with a sufficient voltage rating.
Ceramic capacitors also make a good choice for the input decoupling capacitor, which should be placed as close as possible to the LT3489. A $2.2 \mu \mathrm{~F}$ to $4.7 \mu \mathrm{~F}$ input capacitor is sufficient for most applications. Table 2 shows a list of several ceramic capacitor manufacturers. Consult the manufacturers for detailed information on their entire selection of ceramic parts.

Table 1. Recommended Inductors

| PART | $\mathrm{L}(\mu \mathrm{H})$ | TYPICAL DCR (m $\Omega$ ) | $\begin{gathered} \text { SIZE } \\ \mathrm{L} \times \mathrm{W} \times \mathrm{H}(\mathrm{~mm}) \end{gathered}$ | VENDOR |
| :---: | :---: | :---: | :---: | :---: |
| SD25-2R2 | 2.2 | 31 | $5.45 \times 5.45 \times 2.7$ | CooperBussmann |
| SD25-3R3 | 3.3 | 38 |  | (888) 414-2645 |
| SD25-4R7 | 4.7 | 47 |  | www.cooperet.com |
| A916CY-2R7M | 2.7 | 18.3 | $6 \times 6 \times 3.5$ | Toko |
| A916CY-3R3M | 3.3 | 21.4 |  | www.toko.com |
| A916CY-4R7M | 4.7 | 26.3 |  |  |
| LQH55DN2R2M03 | 2.2 | 29 | $5.7 \times 5 \times 4.7$ | Murata |
| LQH55DN3R3M03 | 3.3 | 36 |  | (770) 436-1300 |
| LQH55DN4R7M03 | 4.7 | 41 |  | www.murata.com |

Table 2. Ceramic Capacitor Manufacturers

| Taiyo Yuden | (408) 573-4150 <br> www.t-yuden.com |
| :--- | :--- |
| AVX | (843) 448-9411 <br> www.avxcorp.com |
| Murata | (770) 436-1300 <br> www.murata.com |

## APPLICATIONS INFORMATION

## Diode Selection

Schottky diodes, with their low forward voltage drop and fast switching speed, are ideal for LT3489 applications. Table 3 lists several Schottky diodes that work well with the LT3489. The diode's average current rating must exceed the average output current. The diode's maximum reverse voltage must exceed the output voltage. The diodeconducts current only when the power switch is turned off (typically less than $50 \%$ duty cycle), so a 3A diode is sufficient for most designs. The companies below also offer Schottky diodes with high voltage and current ratings.

Table 3. Suggested Diodes

| MANUFACTURER <br> PART NUMBER | MAXIMUM <br> CURRENT (A) | MAXIMUM <br> REVERSE <br> VOLTAGE (V) | MANUFACTURER |
| :--- | :---: | :---: | :--- |
| UPS340 | 3 | 40 | Microsemi <br> www.microsemi.com <br> UPS315 |
| B220 | 2 | 15 | 20 |
| B230 | 2 | 30 | www.diodes.com |
| B240 | 2 | 40 |  |
| B320 | 3 | 20 |  |
| B330 | 3 | 30 |  |
| B340 | 3 | 40 |  |
| SBM340 | 3 | 40 |  |

## Frequency Compensation

To compensate the feedback loop of the LT3489, a series resistor-capacitor network should be connected from the COMP pin to GND. For most applications, a capacitor in the range of 220 pF to 680 pF will suffice. A good starting value for the compensation capacitor, $\mathrm{C}_{C}$, is 470 pF . The compensation resistor, $\mathrm{R}_{\mathrm{C}}$, is usually in the range of 20k to 100 k . A thorough analysis of the switching regulator control loop is not within the scope of this data sheet and will not be presented here, but values of 20k and 680pF will be a good choice for many designs.

## Setting Output Voltage

To set the output voltage, select the values of R1 and R2 (see Figure 1) according to the following equation:

$$
\mathrm{R} 1=\mathrm{R} 2 \cdot\left(\frac{\mathrm{~V}_{\mathrm{OUT}}}{1.235 \mathrm{~V}}-1\right)
$$

A good range for $R 2$ is from $5 k$ to $30 k$.

## Board Layout

The high speed operation of the LT3489 demands careful attention to board layout. For high-current switching regulators like the LT3489, the board layout must have good thermal performance. Vias located underneath the part should be connected to an internal ground plane to improve heat transfer from the LT3489 to the PCB board. You will not get advertised performance with careless layout. Thermal and noise consideration must be taken into account. Figure 2 shows the recommended component placement for a boost converter.


Figure 2. Recommended Component Placementfor Boost Converter. Note Direct High Current Paths Using Wide PC Traces. Minimize Trace Area at Pin 1 ( $\mathrm{V}_{\mathrm{C}}$ ) and Pin 2 (FB). Use Multiple Vias to Tie Pin 4 Copper to Ground Plane. Use Vias at One Location Only to Avoid Introducing Switching Currents Into the Ground Plane

## TYPICAL APPLICATIONS

## 8V Output Boost Converter





3489 TA09

## TYPICAL APPLICATIONS

## 12V Output Boost Converter



## LT3489

## TYPICAL APPLICATION



## PACKAGE DESCRIPTION

MS8E Package
8-Lead Plastic MSOP
(Reference LTC DWG \# 05-08-1662)

reLated parts

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| LT1613 | 550 mA (Isw), 1.4MHz, High Efficiency Step-Up DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 0.9 \mathrm{~V}$ to $10 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX) }}=34 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=3 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, ThinSOT ${ }^{\text {TM }}$ Package |
| LT1615/LT1615-1 | $300 \mathrm{~mA} / 80 \mathrm{~mA}$ (Isw), High Efficiency Step-Up DC/DC Converters | $\mathrm{V}_{\text {IN: }} 1 \mathrm{~V}$ to $15 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX) }}=34 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=20 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LT1618 | 1.5A (Isw), 1.25MHz, High Efficiency Step-Up DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 1.6 \mathrm{~V}$ to $18 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX }}=35 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=1.8 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, MS Package |
| LT1930/LT1930A | 1A (Isw), 1.2MHz/2.2MHz, High Efficiency Step-Up DC/DC Converters | $\mathrm{V}_{\text {IN: }}: 2.6 \mathrm{~V}$ to $16 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX) }}=34 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=4.2 \mathrm{~mA} / 5.5 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LT1935 | 2A (Isw), 1.2MHz/2.7MHz, High Efficiency Step-Up DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 2.3 \mathrm{~V}$ to $16 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX) }}=38 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=3 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LT1946/LT1946A | 1.5A (Isw), 1.2MHz, High Efficiency Step-Up DC/DC Converters | $\mathrm{V}_{\text {IN }}: 2.45 \mathrm{~V}$ to $16 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX }}=34 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=3.2 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, MS8 Package |
| LT1961 | 1.5A (Isw), 1.25MHz, High Efficiency Step-Up DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 3 \mathrm{~V}$ to $25 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX }}=35 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=0.9 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=6 \mu \mathrm{~A}$, MS8E Package |
| LT3436 | 3A (Isw), 1MHz, 34V Step-Up DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 3 \mathrm{~V}$ to $25 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX }}=34 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=0.9 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<6 \mu \mathrm{~A}$, TSSOP-16E Package |
| LT3464 | 85mA (Isw), High Efficiency Step-Up DC/DC Converter with Integrated Schottky and PNP Disconnect | $\mathrm{V}_{\text {IN: }}: 2.3 \mathrm{~V}$ to $10 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX }}=34 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=25 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LT3467/LT3467A | 1.1A (Isw), 1.3MHz/2.7MHz, High Efficiency Step-Up DC/DC Converters | $\mathrm{V}_{\text {IN: }}: 2.6 \mathrm{~V}$ to $16 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX) }}=40 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=1.2 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LT3477 | 3A (Isw), 3.5MHz, High Efficiency Step-Up DC/DC Converter with Dual Rail-to-Rail Current Sense | $\mathrm{V}_{\text {IN: }}: 2.5 \mathrm{~V}$ to $24 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX) }}=40 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=5 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}, \mathrm{QFN}$, TSSOP-20E Packages |
| LT3479 | 3A (Isw), 3.5MHz, High Efficiency Step-Up DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 2.5 \mathrm{~V}$ to $24 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MAX) }}=40 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=5 \mathrm{~mA}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}, \mathrm{DFN}$. TSSOP-16E Packages |

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